EUROPEAN CURRICULUM VITAE

PERSONAL INFORMATION



PHD MICHELE CALABRETTA

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Sex Male | Date of birth 11/09/1981 | Nationality Italian Status Married

WORK EXPERIENCE

Dates (from – to)
 Name and address of employer
 Type of business or sector
 Occupation or position held
 Main activities and responsibilities

06/2021 – Now

STMicroelectronics S.r.I., Stradale Primosole 50,95121Catania (CT), Italy

Power Electronics, R&D

their impact in terms of reliability degradation. Responsible for the R&D interaction with University of Catania and member of the Organizing Committee for the Master in Power Electronics. Representative member of ST within ECPE Organization. considering thermal and structural interaction) to describe the stressing applicative conditions and at traction inverter level). Building-up of multi-physics models (from TCAD to final electrical model failure mechanisms under reliability test conditions and in the final mission profile reliability (mainly (SAM,optical microscopy) and destructive investigation (sample preparation by mechanical and Dynamic Tests with high slew rate) and material characterization. The scope of the R&D Physical (team made by 8 Engineers and physics) is focused on Reliability assessments (Thermal-Cycling, Shocks, Environmental Sequences, High Temperature Biased tests (HTRB, HTGB, H3TRB and Technology Qualification Reliability Physics. In charge for Reliability investigation and analysis on Power Devices (Discrete and Modules) for Automotive Applications. Responsible for both the R&D Advanced Reliability and Physical Analysis Laboratories. The Advanced Reliability Laboratory Member of the ST QMT (Quality, Manufacturing & Technology) R&D Board. Responsible for Power & Discrete R&D, Technology Reliability Physics Director lon milling, SEM, TEM). Aim of the activity is to characterize the device degradation and the related Lab (team made by 7 Physics) is linked to physical characterization by means of non-denstructive

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12/2013 - 06/2021

STMicroelectronics S.r.I., Stradale Primosole 50,95121Catania (CT), Italy Power Electronics, R&D

Advanced Simulation and Characterization Manager

simulation and material characterization (mainly focusing on Back-End aspects, both on discrete and Power Module, and on front/back metallization/passivations). simulation models and creation of a team for Power devices design and optimization through Responsible for creation and development of the "Advanced Simulation and Characterization Team" within the Automotive & Discrete Group (ADG). Building-up of thermo-mechanical

(SiC, GaN) and new technology development (thin wafers). high temperature/improved fatigue applications and for activity related to innovative compounds development (diffusion soldering, sintering, Cu metallization), Front-End/Back-End interfaces for Responsible for mechanical/tribological characterization activities related to new metallurgic joint

Reliability definition and verification. Responsible for "R&D Advanced Reliability Lab", in charge for reliability assessment at R&D level (Power Cycling, Thermal Cycles/Thermal Shocks and High Temperature/Humidity die related biased tests) and for all relevant failure mechanism modeling enabling the Mission Profile

Vehicles' "Qualification of Power Modules for Use in Power Electronics Converter Units (PCUs) in Motor Packages characterization and reliability. Representative for STMicroelectronics and team member at ECPE (European Center for Power Electronics) for AQG324 Specification for debug and for failure analysis investigation in reliability and applicative testing conditions. Research affiliation at CNR-IMM (Italian National Council for the Research, Institute for Responsible for "R&D Physical Lab" for physical investigation on new technology and process Microelectronics and Microsystems) as industrial researcher fellow for Power Electronics

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Main activities and responsibilities

06/2011 - 12/2013

STMicroelectronics S.r.I., Stradale Primosole 50,95121Catania (CT), Italy

Power Electronics, R&D

Senior Packaging Engineer

attach (AuSn and CuSn diffusion soldering, Innolot alloy and hybrid glue), top side interconnections studies (Al clad, dip attach), substrates characterization (AMB and DBC) and molding compound thermo-mechanical characterization (DMA, TMA, TGA) and optimization for discrete and module packaging (potted and molded). Development of characterization packaging product portfolio Responsible for "Golden Flow Optimization" for the PTD "Power Transistor Division" in terms of methodology (both experimental and simulation tools) for packaging reliability optimization Packaging Engineering. Technical monitoring of maturity level milestones for Packaging Qualification up to mass production release. Process definition and optimization on Innovative die-PE&D (Packaging Engineering and Development) process engineer responsible for Through-Hole

 Dates (from – to) Name and type of organization providing education and training 	• Dates (from – to) • Name and type of organization providing education and training • Principal subjects/occupational skills covered • Title of qualification awarded • Thesis title • Type of thesis	 Dates (from – to) Name and address of employer Type of business or sector Occupation or position held Main activities and responsibilities 	 Dates (from – to) Name and address of employer Type of business or sector Occupation or position held Main activities and responsibilities 	 Dates (from – to) Name and address of employer Type of business or sector Occupation or position held Main activities and responsibilities 	 Dates (from – to) Name and address of employer Type of business or sector Occupation or position held Main activities and responsibilities
09/2000-05/2006 Scuola Superiore di Catania per la Formazione d'Eccellenza, Via S. Nullo 5/i, 95123 Catania, Tel:+39 095351568	 01/2007 - 02/2010 Catania University, Department of Mechanic Engineering, Viale Andrea Doria 6, 95123 Catania, Tel:+39 095 7381111 Numerical Analysis, Mechanical Design , Multi-body-system calculation, Experimental vibration, NVH, Acoustic, FEA, computation stress analysis and fatigue PhD in Applied Mathematics to Engineering Multibody-Dynamic Calculation of the cranktrain system of a V12 high performance engine Numerical/experimental 	03/2002 – 12/2002 CNR-IMM., Stradale Primosole 5095121Catania (CT), Italy Research Institution Trainee for "Scuola Superiore di Catania" Nano-cantilever and MEMS structures design and fabrication.	06/2005 – 12/2005 Ferrari S.P.A., Via Abetone Inferiore 4 41053 Maranello (MO), Italy Powertrain research and development Trainee Numerical model construction and experimental correlation for F430 cranktrain.	01/2006 – 04/2008 Ferrari S.P.A.,Via Abetone Inferiore 4 41053 Maranello (MO), Italy Powertrain research and development Powertrain R&D Engineer, Multi-Body-Dynamic calculation engineer Responsible for multy-body and structural dynamic/vibration analysis of road vehicles' powertrain. Numerical model correlation with test bench and vehicle testing for structural dynamic and reliability subjects.	04/2008 – 06/2011 Automobili Lamborghini S.P.A., Via Modena 12, 40019 Sant'Agata Bolognese (BO), Italy Powertrain research and development Engine R&D Team Leader for CAE & Simulation Responsibility of both "Structural Mechanics" and "Computational Fluid-dynamics" modeling. Responsible for Powertrain components definition, calculation and optimization up to final release in production. Full development of a completely new V12 engine (Lamborghini Aventador). Link responsible for Know-how research development with suppliers, AUDI-VW group and Universities for structural, dynamics and reliability subjects.

	Reading skillsWriting skillsVerbal skills	OTHER LANGUAGES	MOTHER TONGUE:	PERSONAL SKILLS AND COMPETENCES	Interor qualinication awarded Level in national classification	skills covered	Principal subjects/occupational	Dates (from – to) Name and type of organization	•Type of thesis	 Title of qualification awarded Thesis title 	skills covered	 Principal subjects/occupational 	 Dates (from – to) Name and type of organization 	Type of thesis	•Thosis title	 Principal subjects/occupational skills covered Title of qualification awarded
German	ENGLISH FLUENT FLUENT FLUENT		ITALIAN		Secondary school Diploma di maturità	Maturity priority (actor A00/000 with because)	Mathematice Drusice Chemistry Latin Enclish	09/1995 – 07/2000 Liceo Scientifico Statale Leonardo Giarre (CT): high school	Numerical/experimental; produced in collaboration with Ferrari S.p.A.	Master degree in Mechanical Engineering (note: 110/110 with honours)	Engines, Vehicle mechanics and design, Industrial technical drawing, Design and manufacture, Organization and management of industrial processes	Tel:+39 095 7381111 Mechanical Design, Vibration of complex mechanical systems, FEM, Mathematics, Physics,	09/2000 – 10/2005 Università di Catania-Facoltà di Ingegneria, Viale Andrea Doria 6, 95123 Catania,	Numerical/experimental	70/70 with honours). Multibody-Dynamic Calculation of a chain timing mechanism of a V12 high performance I C E	Numerical Calculation, Non-linear analysis, Interaction fluid-structure, Statistics, Statistic mechanics, Information technology Diploma di Licenza della Scupla Superiore di Catania /hich excellence university centre: note:

		PATENT		ADDITIONAL INFORMATION	TECHNICAL SKILLS AND COMPETENCES	SOCIAL SKILLS AND COMPETENCES	Reading skills Writing skills Verbal skills
Calabretta M., Russo S., Torrisi M., Renna M., "Method for the manufacture of integrated devices including a die fixed to a leadframe", US Patent 20200294950A1, CN Chinese Patent 111682008A	Smerzi S., Calabretta M., Sitta A., Renna M., "Process for manufacturing a strained semiconductor device and corresponding strained semiconductor device", US Patent 20190326231A1	Girlando G., Calabretta M.,Pappalardo F., "Monitoring device with jumper cable coupling and related methods", US Patent 20150253268 A1	convergences Areas (Meridione d'Italia). -Author of more than 50 papers published in technical journals and international conferences. -I've developed my problem solving attitude since secondary school's years participating to Olympic Mathematics and Physics games, attending the national selection and being awarded at national level in 1999 and 2000. Author of more than 80 conference and technical paper.	-In 2012 I was selected as representative of STMicroelectronics to attend the four months Program "Alta Scuola di Formazione Francesco Saverio Nitti", sponsored by Ministry of Economic Development, developing economical and managerial skill in using granted funds in	Excellent knowledge of computer programs such as MSC Suite (ADAMS, ADAMS/Engine, ADAMS/Car, program language ADAMS/Macro, Patran, Nastran, MARC); ANSYS; Matlab, Simulink; Pro-E; CATIA V5; Unix /Linux; program languages C/C++ and COMSOL Multiphysics. Author of more than 70 technical and conference papers.	During my working experiences I developed technical competencies in both Automotive and semiconductor industry and I've gradually grown my managerial skills managing people and economical budgets. My professional experiences allowed me to develop strong communicative and team working competences.	Good Basic Good